SHARP

		Spec No.DG-166002Issue15-Sep-16
SPE	CIFIC	ATIONS
Product Type	ZENIGA	TA LED
Model No.	GW6NG	NKCS06
	e any objections, please conta	including the cover and appendix. act us before issuing purchasing order. Reference
DATE:		
BY:	PRESE	NTED
	BY:	
	Dept. G	eneral Manager
	REVIE	WED BY: PREPARED BY:
	LIGHT	LOPMENT DIV. II ING BUSINESS UNIT RONIC COMPONENTS AND DEVICES BU ? CORPORATION

1. These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp"). Please handle with great cares and do not reproduce or cause anyone to reproduce them without Sharp's consent.

2. When using this Sharp product, please observe the absolute maximum ratings, other conditions and instructions for use described in the specification sheets, as well as the precautions mentioned below.

Sharp assumes no responsibility for any damages resulting from use of the product which does not comply with absolute maximum ratings, other conditions and instructions for use included in the specification sheets, and the precautions mentioned below.

(Precautions)

- (1) In making catalogue or instruction manual based on the specification sheets, please verify the validity of the catalogue or instruction manuals after assembling Sharp products in customer's products at the responsibility of customer.
- (2) This Sharp product is designed for use in the following application areas ;
 - Computers OA equipment Telecommunication equipment (Terminal) Measuring equipment
 - Tooling machines ·Audio visual equipment · Home appliances

If the use of the Sharp product in the above application areas is for equipment listed in paragraphs (3) or (4), please be sure to observe the precautions given in those respective paragraphs.

- (3) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when Sharp product is used for equipment in responsibility of customer which demands high reliability and safety in function and precision, such as ;
 - Transportation control and safety equipment (aircraft, train, automobile etc.)
 - Traffic signals Gas leakage sensor breakers Rescue and security equipment
 - · Other safety equipment

(4)Sharp product is designed for consumer goods and controlled as consumer goods in production and quality.

Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as ;

- Space equipment Telecommunication equipment (for trunk lines)
- Nuclear power control equipment
 Medical equipment
- (5) Please contact and consult with a Sharp sales representative if there are any question regarding interpretation of the above four paragraphs.
- 3. Disclaimer

The warranty period for Sharp product is one (1) year (or six (6) months in case of generalized product) after shipment. During the period, if there are any products problem, Sharp will repair (if applicable), replace or refund. Except the above, both parties will discuss to cope with the problems.

The failed Sharp product after the above one (1) year (or six (6) month for generalized product) period will be coped with by Sharp, provided that both parties shall discuss and determine on sharing responsibility based on the analysis results thereof subject to the above scope of warranty.

The warranty described herein is only for Sharp product itself which are purchased by or delivered to customer. Damages arising from Sharp product malfunction or failure shall be excepted.

Sharp will not be responsible for the Sharp product due to the malfunction or failures thereof which are caused by: (1) storage keep trouble during the inventory in the marketing channel.

(2) intentional act, negligence or wrong/poor handling.

(3) equipment which Sharp products are connected to or mounted in.

(4) disassembling, reforming or changing Sharp products.

(5) installation problem.

(6) act of God or other disaster (natural disaster, fire, flood, etc.)

(7) external factors (abnormal voltage, abnormal electromagnetic wave, fire, etc.)

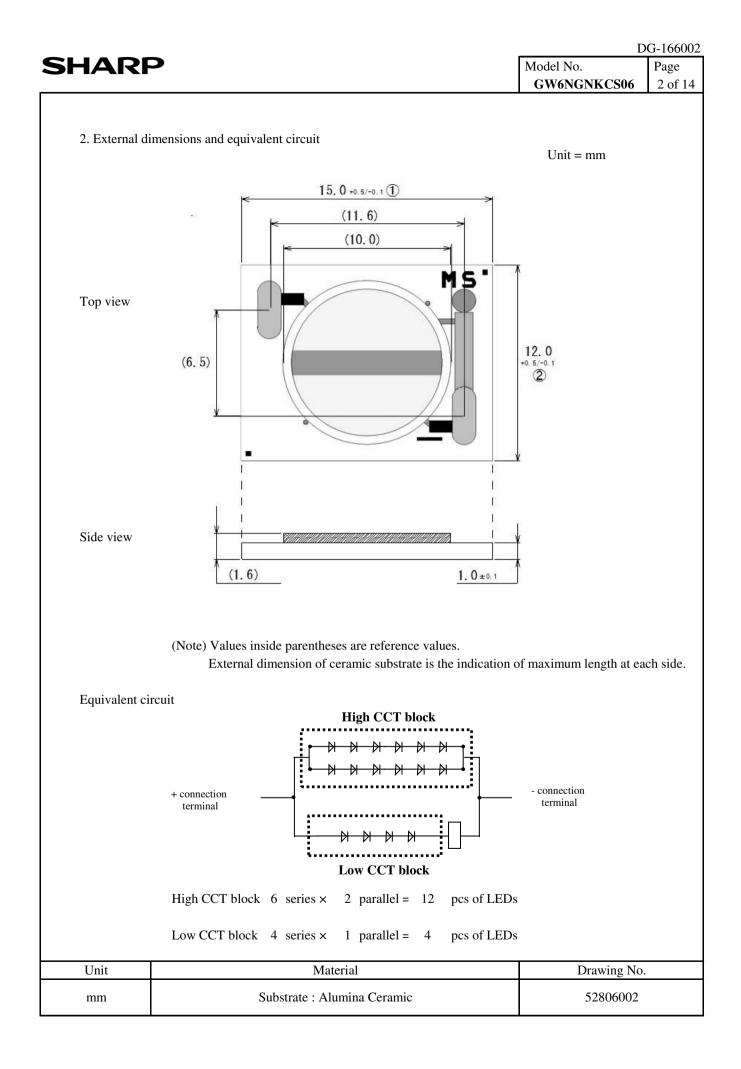
(8) special environment (factory, coastal areas, hotspring area, etc.)

(9) phenomenon which cannot be foreseen based on the practical technologies at the time of shipment.

(10) the factors not included in the product specification sheet.

4. Please contact and consult with a Sharp sales representative for any questions about Sharp product.

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GW6NGNKCS06 specification	ons	
 Application These specifications apply to the light emitting diode module Mod [LED module (InGaN Blue LED chip + Phosphor)] Main application : Lighting 	del No. GW6NGNKCS06.	
2. External dimensions and equivalent circuit	Refer to Page 2	
3. Ratings and characteristics	Refer to Page 3 - 5.	
3-1. Absolute maximum ratings		
3-2. Electro-optical characteristics		
3-3. Derating curve		
4. Reliability	Refer to Page 6.	
4-1. Test items and test conditions		
4-2. Failure criteria		
5. Quality level	Refer to Page 7.	
5-1. Applied standard		
5-2. Sampling inspection		
5-3. Inspection items and defect criteria		
6. Supplements	- Refer to Page 8 - 10.	
6-1. Chromaticity rank table	-	
6-2. Packing		
6-3. Label		
6-4. Indication printed on product		
7. Precautions	- Refer to Page 11 - 13.	
8. Characteristics diagram (TYP.)	Refer to Page 14.	



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3. Ratings and characteristics

3-1. Absolute maximum ratings

Item	Symbol	Rating	Unit
Power Dissipation *1,4	Р	7.7	W
Forward Current *1,4	I _F	400	mA
Reverse Voltage *2,4	V _R	-15	V
Operating Temperature *3	T _{opr}	- 30 ~ + 100	°C
Storage Temperature	T _{stg}	- 40 ~ + 100	°C

*1 Power dissipation and forward current are the value when the module temperature is set lower than the rating by using an adequate heat sink.

*2 Voltage resistible at initial connection error

(Not dealing with the possibility of always-on reverse voltage.)

*3 Case temperature Tc (Refer to measuring point for case temperature in the next page.) Refer to "Derating curve" in the next page as for operating current.

*4 Tc= 25 °C

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3-2. Electro-optical characteristics

								(-)	_0 0)
CCT	Item	Symbol	C	onditi	on	MIN.	TYP.	MAX.	Unit
	Forward Voltage *5	VF				12.3	13.8	15.0	V
	Luminous Flux *6	Φ	$\mathbf{I}_F =$	= 50	mA	48	(53)	-	lm
1900K	Chromaticity Coordinates *7	х				-	(0.5377)	-	-
		У				-	(0.4130)	-	-
	General Color Rendering Index *8	Ra				90	(92)	-	-
	Forward Voltage *5	VF	$\mathbf{I}_{\mathrm{F}} =$	= 350		16.5	18	19.2	V
	Luminous Flux *6	Φ			0 mA	540	(600)	-	lm
3000K	Characteristic Characteristic +7	х				-	(0.4370)	-	-
	Chromaticity Coordinates *7	у				-	(0.4030)	-	-
	General Color Rendering Index *8	Ra				90	(94)	-	-

(Note) Values inside parentheses are shown for reference purpose only.

- *5 (After 5 ms drive, Measurement tolerance: $\pm 3 \%$)
- *6 Monitored by Sharp's 1m integrating sphere and Otsuka electronics SR-2000A (After 5 ms drive, Measurement tolerance: ± 10 %)
- *7 Monitored by Sharp's 1m integrating sphere and Otsuka electronics SR-2000A (After 5 ms drive, Measurement tolerance: ± 0.005)
- *8 Monitored by Sharp's 1m integrating sphere and Otsuka electronics SR-2000A (After 5 ms drive, Measurement tolerance: ± 2)

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 $(T_i = 25 \ ^{\circ}C)$

DG-166002 SHARP Model No. Page GW6NGNKCS06 5 of 14 3-3. Derating curve Forward Current Derating Curve 400 Forward Current I_F [mA] 300 200 100 0 -20 -10 10 20 30 40 60 70 80 90 -30 0 50 100 110

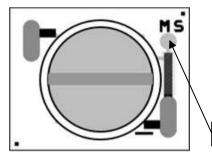
(Note) To keep the case temperature lower than the rating, enough heat-radiation performance needs to be secured by using an adequate heat sink.

Case Temperature T_c [°C]

For soldering connection, please evaluate in your circumstance to make sure soldering reliability. (Above derating curve is specified to LED device, not for soldering connection) And please consider to avoid physical stress between wire and substrate, and some protection like silicon bond on top of soldered wire is recommended.

Please ensure the maintenance of heat radiation not to exceed case temperature over the rating in operation.

(Measuring point for case temperature)



Please take note of the following, when measuring case temperature.

- 1 The LED device mounting surface should be flat/plain surface.
- 2 The substrate surface temperature should be uniform.
- 3 Do not solder this area when you measuring case temperature.

measuring point

Thermal Resistance: 6.0 °C/W(Typical value)

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4. Reliability

The reliability of products shall be satisfied with items listed below.

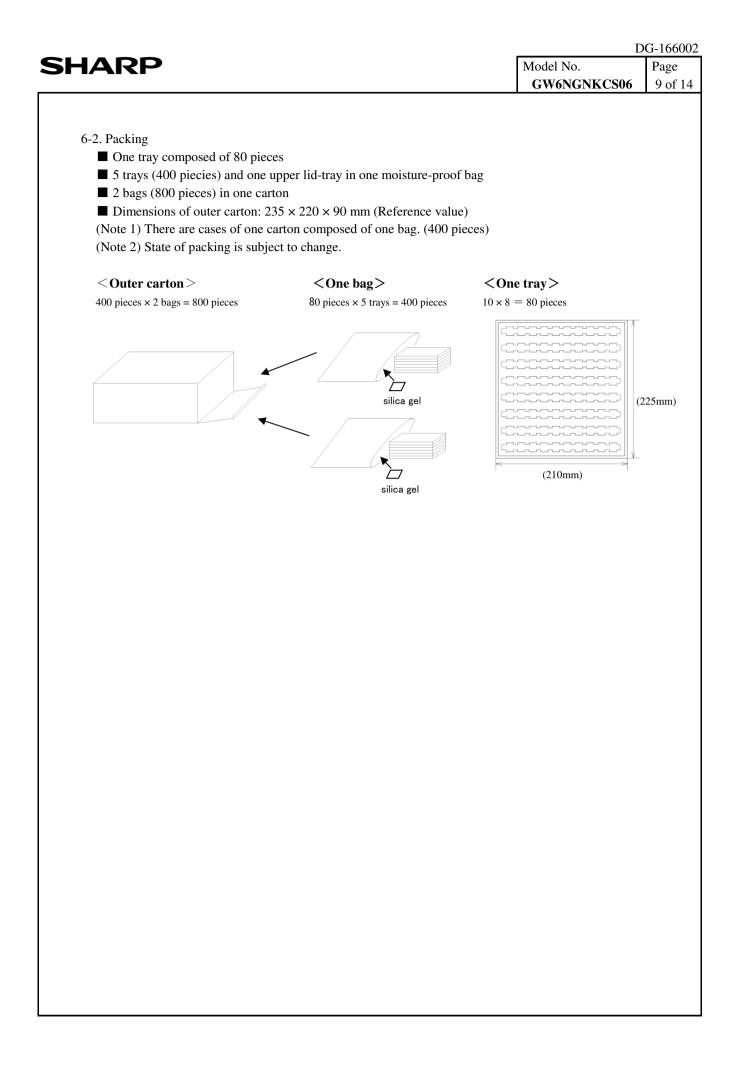
4-1. Т	Test items and test condit	tions	Co	nfidence le	vel: 90 %
No.	Test item	Test conditions	Samples	Defective	LTPD
			n	С	(%)
1	Temperature Cycle	- 40 °C(30 min) \sim + 100 °C(30 min), 100 cycles			
			11	0	20
2	Temperature Humidity	$T_{stg} = +60 ^{\circ}\text{C}, \text{RH} = 90 ^{\circ}\text{, Time} = 1000 \text{ h}$			
	Storage		11	0	20
3	High Temperature	$T_{stg} = +100^{\circ}C$, Time = 1000 h			
	Storage		11	0	20
4	Low Temperature	$T_{stg} = -40 \text{ °C}, \text{ Time} = 1000 \text{ h}$			
	Storage		11	0	20
5	Steady State Operating	$T_c = 90 \text{ °C}, I_F = 350 \text{ mA}, \text{ Time} = 1000 \text{ h}$			
	Life		11	0	20
6	Shock	Acceleration: 15000 m/s ² , Pulse width: 0.5 ms			
		Direction: 3 directions (X, Y and Z)			
		3 trials in each direction	5	0	50
7	Vibration	Frequency: 100 to 2000 Hz for 4 minutes per trial			
		Acceleration: 200 m/s ²			
		Direction: 3 directions (X, Y and Z)			
		4 trials in each direction	5	0	50

4-2. Failure criteria

No.	No. Parameter Symbol		Failure criteria
1	Forward Voltage	V _F	$V_F > Initial value \times 1.1$
2	Luminous Flux	Φ	Φ < Initial value × 0.7

	RP	1	Model No.	DO
			GW6NGNKC	S06
5. Qu	ality level			
	Applied standard SO2859-1			
A 5-3.1	Inspection items a	mpling plan, level S-4.		
No.	Item	Defect criteria	Classification	AQL
1	No radiation	No light emitting	Major defect	0.1
2	Electro-optical characteristics	Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity)		
	East a sea al			
3	External dimensions	Not conforming to the specified dimensions (External dimensions of (1) and (2) shown in Page 2)		
3			Minor defect	0.4

						Model No. GW6NGNKCS06	Page 8 of 1
6. Supplements							
6-1. Chromaticit	y rank table				(Tolerance	$(T_j = 25 °C)$	
		Chromatic	eity Diagran	n			
ランク		Point 1 Point 2	Point 3	Point 4			
1900		0.5231 0.5445	0.5523	0.5309			
1 (I _f =50m	,	0.4080 0.4080	0.4180	0.4180			
1 3000 (I _f =350n	-	0.42870.44040.39800.3980	0.4454 0.4080	0.4334 0.4080			
		C	hromaticity D	iagram			
0.440		! ! !					
0.420	/						
		5 7					
> 0.400	3200K	•7					



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		GW6NGNKCS06 10 c
3. Label		
1)Outer carton		
Following label is attached or	outer carton	
(Note 3) Label format is subjected to		1) Lot No. indication
(1000 5) Eaber format is subjected to	enange.	XX 11 B 25
SHIPMENT TABLE		$\begin{array}{cccccccccccccccccccccccccccccccccccc$
PART NO. GW6NGNKCS06	←Model number	 Production plant code
(GW6NGNKCS06M)	←(M odel number+suffix code)	 2 Shipping year (Year last 2 digits)
QUANTITY: 800	←Quantity ←Lot No.	3 Shipping month
LOT No. XX11B25 RANK 1	←Rank	(from January to December in ABC order
SHARP CORPORATION R.C.	←Production country	(4) Shipping date $(01 \sim 31)$
MADE IN XXXXXXXXXX (R.U.)	MADE IN INDONESIA	*Notation may be different
SHARP LABEL		
2)Moisture-Proof bag		
Following label is attached or		
(Note 3) Label format is subjected to	change.	1) Lot No. indication
		XX 1 9 G 11 123 A
SHIPMENT TABLE	0	
PARI NO. GWONGNAGSUD	-Model number -(Model number+suffix code)	(1) Production plant code
(GWONGWKGSOOM)	-Quantity and rank	② Shipping year (Year last digit)
LOT No. 5020G2064A *	-Lot No.	 ③ Shipping month (1~9 or O, N, D) ④ Fixed code G
SHARP CORPORATION		 ④ Fixed code G ⑤ Shipping date(01~31)
MADE IN XXXXXXXXXX R.C.	-Production country	Suppling date (01, ~31)
		6 Serial No
SHAPP LABEL	·MADE IN INDONESIA	⑥ Serial No.⑦ Backup code A

*Notation may be different

6-4. Indication printed on product

Model No. and control No. are indicated on substrate surface.

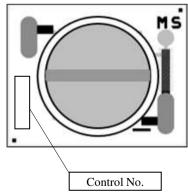
1) Control No.

Indicated as	foll	ows	5;	
GNKC6	1	4	F	11
1	2	3	4	5

- 1 Abbreviated Model No.
- 2 Chromaticity Rank
- (3) Year of production (Year end 2014⇒"4")
- 4 Month of production

(to be indicated alphabetically with January corresponding to A)

(5) Date of production (01 \sim 31)



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7. Precautions			
① Storage conditions			
Please follow the conditions below.			
• Before opened: Temperature 5 \sim 30 °C, Relative humidity less than 6	i0 %.		
(Before opened LED should be used within a year)			
\cdot After opened: Temperature 5 \sim 30 $^\circ \! \mathrm{C}$, Relative humidity less than 60	%.		
(Please apply soldering within 1 week)			
•After opened LED should be kept in an aluminum moisture proof bag w	vith a moisture		
absorbent material (silica gel).			
• Avoid exposing to air with corrosive gas.			
If exposed, electrode surface would be damaged, which may affect sold	ering.		
② Usage conditions			
This product is not designed for the use under any of the following cond			
Please carefully check the performance and reliability well enough in ca	se of using under any of the		
following conditions;			
• In a place with a lot of moisture, dew condensation, briny air, and corro	sive gas.		
(Cl, H2S, NH3, SO2, NOX, etc.)			
•Under the direct sunlight, outdoor exposure, and in a dusty place.			
•In water, oil, medical fluid, and organic solvent.			
Please do not use component parts like rubber which may contain sulfur	(gasket packing, adhesive mat	terial,	
etc.).			
Please note that any strong acidic or alcoholic elements could effect the s			
The heat and light released from the LED device, could generate halogen which may have adverse impact on the module. Before using please cons			
③ Heat radiation and Installation			
If forward current (IF) is applied to single-state module at any current, th or emitting smoke, due to increase in temperature.	nere is a risk of damaging LEI	D	
Equip with specified heat radiator(heat sink), and avoid heat being stuffe	d inside the module.		
Material of substrate is alumina ceramic. If installed inappropriately, trou		ion may	
occur, which may result in board cracks or lighting defects due to overh		-	
installation.			
Refer to the following cautions while installing the LED device on heat s	ink.		
•Apply thermolysis adhesive, adhesive sheet or peculiar connector when	mounted on heat radiator.		
In case of applying adhesive or adhesive sheet only, check the effective	ness and reliability before fixi	ing.	
If LED comes off from heat radiator, unusual temperature rise entails ha	-	-	
device deterioration, coming off of solder at leads, and emitting smoke,	-		
•When LED device is mechanically fixed or locked, Please take into con	sideration regarding the meth	od of	
attachment due to fail from stress.			
•Please apply appropriate stress and design carefully, when fixing the LE	ED device using holder. Any		
excessive or uneven stress could break LED device's substrate.			
•Avoid convexly uneven boards.			
Convex board is subject to substrate cracking or debasement of heat rele	ease		

Convex board is subject to substrate cracking or debasement of heat release.

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 It is recommended to apply adhesive or adhesive sheet with high thermal of for radiation of heat effectively. Please take care about the influence of color change of adhesive or adhesi period, which may affect light output or color due to change of reflectance. Any excessive or uneven stress on the ceramic substrate could break the su proper/uniform stress is applied on the substrate, when fixing the LED de When fixing the LED device with a holder, please take note if any excessi when pressing the substrate with holder. Due to this, the gap may arise be adhesive material, which may affect the heat dissipation of the device. Do not touch resin part including white resin part on the surface of LED. No light emission may occur due to damage of resin or cutting wire of LI When using tweezers, please handle by ceramic substrate part and avoid to For mounting, please handle by side part of ceramic or the specified area short. 	conductivity ve sheet in initial and long t e from backside. ubstrate. Please design such vice using a holder. ve or uneven stress is applie tween LED device and EDs by outer force. uching resin part. nown below.	term
The current control circuit on the substrate has current controlling function. Therefore, do not touch or damage this area when handling the LED at the touch or damage the current control	time of mounting or after m	ounting.
Handling area	1	
• The outer edges of the substrate may be uneven in some cases. Please aver points, while designing for installation.	oid choosing these areas as f	fixing
 In case of using heat radiation sheet or heat radiation adhesive, light refle materials may influence the output of LED device. Especially, the color c long-term use has direct impact on output of LED devices, and hence card 	hange that occur due to	

•Use soldering iron with thermo controller (tip temperature 380 °C), within 5 seconds per one place.

- Secure the solderwettability on whole solder pad and leads.
- During the soldering process, put the ceramic board on materials whose conductivity is poor enough not to radiate heat of soldering.
- •Warm up (with using a heated plate) the substrate is recommended before soldering. (preheat condition: 100 $^{\circ}$ C \sim 150 $^{\circ}$ C, within 60 sec)
- Avoid touching any part of resin with soldering iron.
- This product is not designed for reflow and flow soldering. Please do not use solder paste for soldering pad.
- · Avoid such lead arrangement as applying stress to solder-applied area.
- Please do not detach solder and make re-solder.
- ·Please solder evenly on each electrode.
- •Please prevent flux from touching to resin.
- •Do the soldering on stable stand. Avoid soldering on moving or vibrating objects.
- Please avoid touching the soldering unit to resin.

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IARP	Model No. GW6NGNKCS06	Page 13 of	
5	Static electricity		
J	This product is subject to static electricity, so take measures like wearing wris Install circuit protection device to drive circuit, if necessary.	t band to cope with it.	
6	Drive method		
	• Any reverse voltage cannot be applied to LEDs when they are in operation of Design a circuit so that any flow of reverse or forward voltage can not be app when they are out of operation.		
	•Module is composed of LEDs connected in both series and parallel.		
	Constant voltage power supply runs off more than specified current amount d caused by temperature rise. Constant current power supply is recommended to		
	•Be cautious while putting on/off the power supply, as excess current, excess injucted to the device in some cases.		ge may
\overline{O}	Cleaning		
	Avoid cleaning, since LED device may be effected in some cases by cleaning.		
8	Color-tone variation		
	Chromaticity of this product is monitored by integrating sphere right after the	-	
	Chromaticity varies depending on measuring method, light spread condition, or Please verify your actual conditions before use.	or ambient temperature.	
	riease verify your actual conditions before use.		
	Safety		
	•Looking directly at LEDs for a long time may result in hurting your eyes.		
	•In case that excess current (over ratings) is supplied to the device, hazardous p abnormal heat generation, emitting smoke, or catching fire can be caused.	phenomena including	
	Take appropriate measures to excess current and voltage.		
	•In case of solder connecting method, there is a possibility of fatigue failure by	v heat.	
	Please fix the leads in such case to protect from short circuit or leakage of ele		ct.
	•Please confirm the safety standards or regulations of application devices.		
	•Please be careful with substrate edges, that may injure your hands.		
10	Other cautions		
	Guarantee covers the compliance to the quality standards mentioned in the spe	ecifications,	
	however it does not cover the compatibility with application of the end-use, in	cluding assembly	
	and usage environment.		
	In case any quality problems occurred in the application of end-use, details wi	Il be separately discusse	d
	and determined between the parties hereto.		

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8. Characteristics diagram (TYP.)

